

DMN2004VK

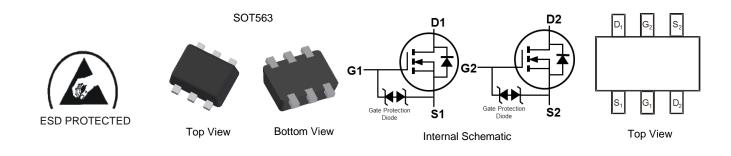
DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2004VK-7	SOT563	3000/Tape & Reel
DMN2004VK-7B	SOT563	8000/Tape & Reel (Note 5)
DMN2004VK-13	SOT563	10000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

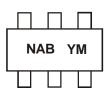
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

5. Change the pitch from 4mm to 2mm in T& R.

Marking Information



 $\begin{array}{l} \mathsf{NAB}=\mathsf{Product} \ \mathsf{Type} \ \mathsf{Marking} \ \mathsf{Code} \\ \mathsf{YM}=\mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \mathsf{Y}=\mathsf{Year} \ (\mathsf{ex:} \ \mathsf{G}=\mathsf{2019}) \\ \mathsf{M}=\mathsf{Month} \ (\mathsf{ex:} \ 9=\mathsf{September}) \end{array}$

Date Code Key

Year	2010		2019	2020	2021	2022	2023	2024	2025	2026	2027	2028
Code	Х		G	Н	I	J	K	L	М	N	0	Р
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (T_A = +25°C, unless otherwise specified.)

	Characteristic	Symbol	Value	Unit	
Drain-Source Voltage			Vdss	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Drain Current (Note 6)	Steady State	T _A = +25°C T _A = +85°C	lo	540 390	mA
Pulsed Drain Current (10µs Pulse,	Duty Cycle = 1%)		IDм	1.5	А

Thermal Characteristics (T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance, Junction to Ambient	Reja	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

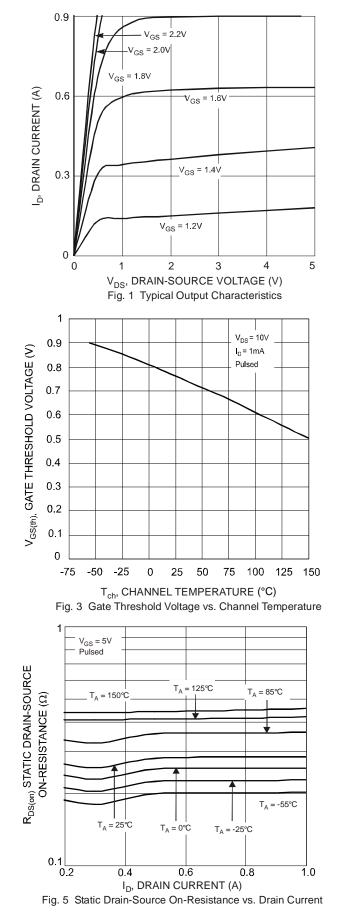
Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

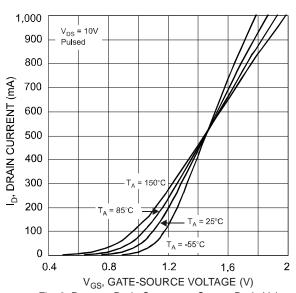
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)				•			
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 16V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_		±1	μA	$V_{GS} = \pm 4.5 V$, $V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	0.5		1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
			0.4	0.55 0.70 0.9	Ω	$V_{GS} = 4.5V, I_D = 540mA$	
Static Drain-Source On-Resistance	RDS(ON)		0.5 0.7			$V_{GS} = 2.5V, I_D = 500mA$	
						VGS = 1.8V, ID = 350mA	
Forward Transfer Admittance	Y _{fs}	200	_		ms	$V_{DS} = 10V, I_D = 0.2A$	
Diode Forward Voltage	Vsd	0.5		1.4	V	V _{GS} = 0V, I _S = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_		150	pF		
Output Capacitance	Coss	_		25	pF	V _{DS} = 16V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_		20	pF		
SWITCHING CHARACTERISTICS (Note 8)							
Turn-On Delay Time	t _{D(ON)}	_	8.0	_	ns		
Rise Time	t _R	_	13.3		ns	$V_{DD} = 10V, R_L = 47\Omega,$	
Turn-Off Delay Time	tD(OFF)		53.5		ns	$I_D = 200 \text{mA. } V_{\text{GEN}} = 4.5 \text{V},$ $-R_G = 10 \Omega$	
Fall Time	tF		36.1		ns	-1022	

Notes:

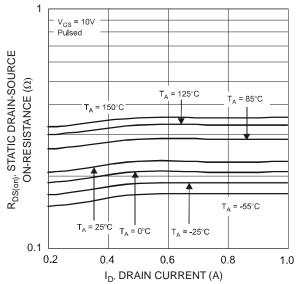
6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.



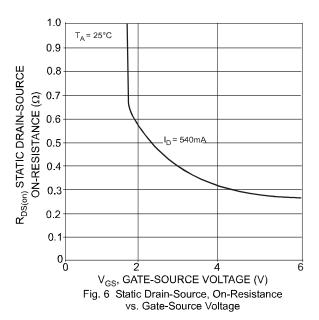






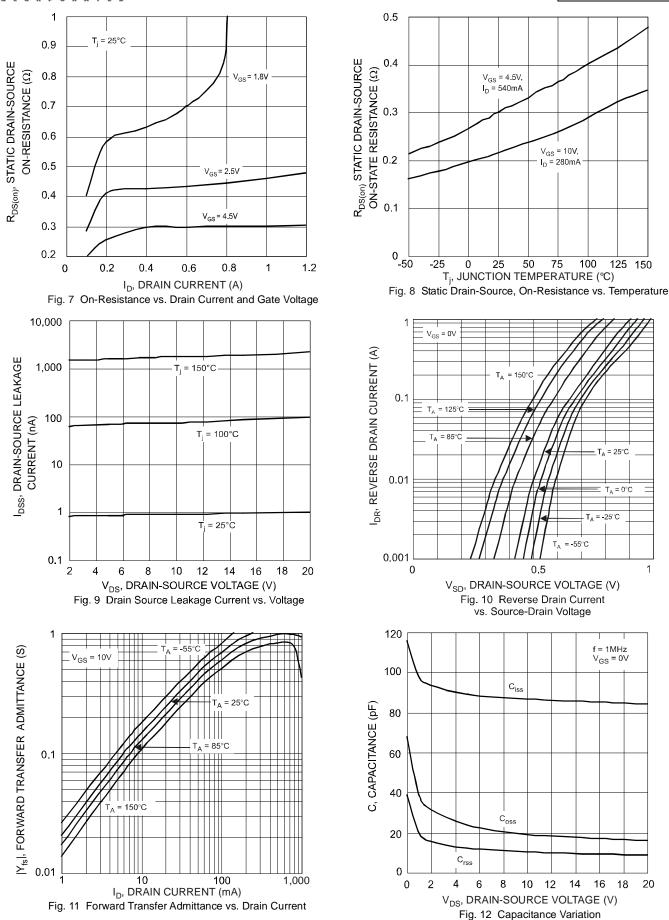












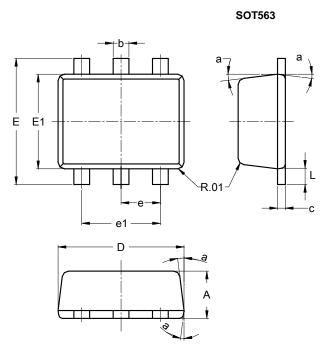
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Package Outline Dimensions

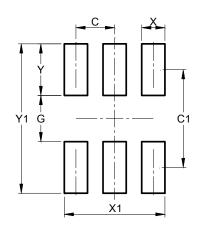
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT563						
Dim	Min	Max	Тур			
Α	0.55	0.60	0.60			
b	0.15	0.30	0.20			
С	0.10	0.18	0.11			
D	1.50	1.70	1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	0.500			
C1	1.270			
G	0.600			
Х	0.300			
X1	1.300			
Y	0.670			
Y1	1.940			

SOT563



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